

Molecular beam epitaxial growth of MoSe₂ on graphite, CaF₂ and graphene

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ABSTRACT: We report the structural and optical properties of molecular beam epitaxy (MBE) grown 2-dimensional (2D) material molybdenum diselenide (MoSe₂) on graphite, CaF₂ and epitaxial graphene. Extensive characterizations reveal that 2H- MoSe₂ grows by van-der-Waals epitaxy on all 3 substrates with a preferred crystallographic orientation and a Mo:Se ratio of 1:2.

Photoluminescence at room temperature (~ 1.56 eV) is observed in monolayer MoSe₂ on both CaF₂ and epitaxial graphene. The band edge absorption is very sharp, < 60 meV over 3 decades. Overcoming the observed small grains by promoting mobility of Mo atoms would make MBE a powerful technique to achieve high quality 2D materials and heterostructures.

TEXT:

Layered materials have been at the center of attention since the discovery of graphene as they hold great promise for uncovering new physical phenomena and for creating new applications. Transition metal dichalcogenides (TMDs) are such materials systems possessing a wide range of energy bandgaps and band alignments. Some of the TMD materials have been shown to exhibit novel properties such as indirect to direct bandgap transition when their thickness is varied from few layers to monolayer^{1,2}, valley-polarized carriers^{3,4,5}, strain dependent bandgap variation^{6,7,8} and more exotic properties like charge density waves⁹ and superconductivity¹⁰. More recently, theoretical^{11,12,13} and experimental¹⁴ study of artificial stacking of these TMD materials is being pursued extensively to create heterostructures that are otherwise difficult to obtain in the conventional 3D epitaxy due to lattice constant mismatch. Most of these studies have been performed by exfoliating thin layers from natural or synthetic crystals^{15,16} obtained using vapor phase transport technique (CVT)^{17,18}. However, the manual stacking method makes the control of rotational orientation between the layered materials difficult. Typically, CVT grown and geological materials are unintentionally doped at rather high levels and the doping could vary spatially and correlated to surface defects potentially induced from the exfoliation process^{18,19}. Lateral TMD heterostructures grown by chemical vapor deposition (CVD) have been recently reported but intermixing of the two materials is observed at the junction region²⁰. Vertical

heterostructure growth that simultaneously achieves spatial control as well as layer control while maintaining a large grain size is yet to be developed^{21,22}. Molecular beam epitaxy (MBE) is widely used for a variety of material systems to obtain electronic grade materials with abrupt interfaces, thickness control and precise doping. Proof of concept MBE growth of TMD materials was demonstrated in early 1990s^{23,24,25,26}. It was shown that 2D TMD thin films could be successfully grown on both 2D and 3D substrates by MBE and chemical beam epitaxy (CBE). More recently, the potential of MBE growth for TMD materials has been exhibited by the in-situ observation using ARPES² of direct to indirect transition of MoSe₂ with increase in layer thickness, as well as giant bandgap renormalization in monolayer MoSe₂²⁷. However, much work is yet needed to provide understanding of the resultant 2D crystal grain size, growth mechanisms and the effect of substrates. Such understanding is essential for preparing electronic grade materials that can enable high performance scalable devices. As a first step towards achieving electronic grade, high-quality 2D crystals, we present a growth study on one model material, MoSe₂, on highly oriented pyrolytic graphite (HOPG), CaF₂ (111) substrates with an inert surface terminated with fluorine, and epitaxial graphene on SiC.

HOPG, CaF₂ and epitaxial graphene on SiC are the three representative substrates used in this study. HOPG is a polycrystalline non-polar layered crystal with no out of plane bonds. CaF₂ is a polar 3D crystal with an inert surface termination. Electronic grade graphene (2D material) prepared on a single crystal substrate (SiC) is an ideal van-der-Waals substrate. Prior to loading into the MBE system, HOPG substrates (SPI Grade1) were cleaved using scotch tape to reveal a fresh surface for growth. The CaF₂ (Crystec) and epitaxial graphene on SiC substrates were cleaned sequentially in chloroform, acetone and methanol. All Substrates were first heated to 800 °C in the growth chamber for 30 mins in vacuum ($\sim 5 \times 10^{-10}$ Torr) to allow desorption of weakly

bound surface contaminants and then cooled to the growth temperature of 400 °C. All growth temperatures in this manuscript are readings from the thermocouple behind the substrate holder. Once the growth temperature was stabilized, Mo and Se were deposited on the substrate simultaneously from the MBE sources in ultra high vacuum (UHV) conditions. Electron-beam evaporation was used for the Mo source, and a Knudsen cell was used for Se source. The Mo ion current was set to ~ 26 nA while the Se beam equivalent pressure (BEP) was maintained at $\sim 6 \times 10^{-6}$ Torr. The growth rate determined by cross-sectional (cs) transmission electron microscopy (TEM) was ~ 0.3 monolayer per minute. The film thickness was varied from 0.6 - 9 monolayers (MLs) to investigate the film morphology, crystallinity and optical properties. After the MBE growth process, the excess selenium was removed in-situ by annealing the samples at 400 °C for ~ 5 -10 minutes in the growth chamber with source shutters closed. The growth process was monitored in-situ by tracking the 10 keV reflection high-energy electron diffraction (RHEED) pattern and further analyzed ex-situ using low energy electron diffraction (LEED), low energy electron reflection (LEER), x-ray photoelectron spectroscopy (XPS), TEM, scanning electron microscopy (SEM), atomic force microscopy (AFM), Raman, photoluminescence (PL) and absorption spectroscopy. The samples for photoluminescence were annealed at 500 °C for 3 minutes and 600 °C for 7 minutes under Se flux before cooling down.

Figures 1a and 1b show the evolution of the RHEED pattern on HOPG. Before growth, the RHEED pattern of only HOPG is detected. After the growth of ~ 0.4 ML MoSe_2 , the RHEED patterns corresponding to both MoSe_2 and HOPG are observed. The ratio of the in-plane lattice constants of MoSe_2 (0.3288 nm) and graphite (0.2461 nm) is 1.336. Since, RHEED pattern is an image in the reciprocal space, the inverse of the spacing ratio of the two sets of RHEED streaks gives a value of 1.333. This ratio is within 2% (within the error of the measurement) of the ratio

of lattice constants of MoSe₂ and HOPG. This implies that the growth proceeds by van der Waals (vdW) epitaxy with no discernable strain. Crystallographically aligned growth of MoSe₂ to the surface orientation of the underlying substrate can be inferred from the fact that we observe RHEED patterns along the $\langle 11\bar{2}0 \rangle$ direction of MoSe₂ and HOPG. Similarly, crystallographically aligned growth is also observed for MoSe₂ grown on CaF₂ and epitaxial graphene. Figures 1c and 1d show that the RHEED streaks of MoSe₂ along $\langle 11\bar{2}0 \rangle$ appear at the same position as the $\langle 110 \rangle$ of CaF₂, as observed previously by Koma et al.²⁸. This is further supported by the in-plane TEM diffraction of MoSe₂ on CaF₂ (Inset g2 of Fig. 3). We observe that the CaF₂ RHEED streaks vanish completely before the MoSe₂ RHEED streaks gradually appear. For an expected MoSe₂ growth of ~0.5 ML, RHEED patterns from neither material was observed. It is worthy to note that even though the CaF₂ RHEED streaks are sharp (Fig. 1c), the RHEED streaks from both 1.5 ML and 3 ML MoSe₂ on CaF₂ (Fig. 1d and Fig. S1c in the Supplementary Information (SI)) are blurry. This is in striking contrast to the sharper MoSe₂ RHEED streaks on HOPG for both 0.6 ML and 3.6 ML growth (Fig. 1b and Fig. S1a in the SI), suggesting a greater disorder in the as grown MoSe₂ on CaF₂ compared to MoSe₂ on HOPG. Removal of fluorine termination and increased reactivity on exposure to electron beam irradiation (i.e. electron stimulated desorption) has been confirmed by oxidation study by A.Koma et al.²⁸. Therefore, care was taken to avoid the continuous exposure of the CaF₂ surface to the RHEED electron beam; only intermittent RHEED measurements were taken.

Fig. 1e-h shows a 2.4 ML MoSe₂ grown on epitaxial graphene on SiC sample characterized by low energy electron microscopy (LEEM). The LEEM image (Fig. 1e) shows a location at which both bare graphene and MoSe₂ on graphene coexist. Micro-LEED (μ LEED) patterns from the

graphene area and MoSe₂/graphene area indicate different crystal morphology, as shown in Fig. 1g and 1f, respectively. The epitaxial graphene is a single crystal with a perfect crystallographic orientation with the SiC underneath. Therefore, clear diffraction sets are seen; the MoSe₂/graphene area shows one set of hexagonal diffraction dots on top of a ring background. The observed ring background is consistent with a structure with a hexagonal lattice constant of $3.25 \pm 0.02 \text{ \AA}$, in agreement with the value of the MoSe₂ in-plane lattice constant of 3.28 \AA . This is also consistent with the RHEED pattern of MoSe₂ on HOPG (Fig. 1b). Therefore we conclude that the bright, continuous region seen in the LEEM image (Fig. 1e) is indeed covered by MoSe₂. With this identification, we can then explain the diffraction pattern of MoSe₂ on graphene. The size of the μ LEED aperture is $8 \mu\text{m}$ and the diffraction pattern over this area results in a stronger set of hexagonal diffraction pattern overlaid on a faint ring. This indicates presence of many small grains, much smaller than the aperture size, most of which have a preferential orientation but some have random orientations. The preferential orientation in this case aligns with the orientation of the underlying graphene substrate. Additionally, Fig. 1f shows the low-energy electron reflectivity (LEER) spectra of monolayer graphene and bilayer graphene along with that of MoSe₂ on graphene. Here we see distinct differences between these spectra, specifically in the energy range of 0 - 6 eV. Graphene's LEER spectrum has a well-established evolution as a function of the number of monolayers present on the surface²⁹. Concerning the MoSe₂ LEER spectrum, this is, as far as we are aware, the first such data presented on this material system. Based on previous work studying LEER of graphene with a first-principles method^{30,31}, we anticipate that the large interlayer spacing of MoSe₂ will result in a small hopping matrix element (which couples interlayer states localized between various layers). As a consequence, it is unlikely that LEEM will be capable of discriminating between different numbers of layers of

TMDs in the same manner as for graphene. Nonetheless, LEEM has allowed us to confirm the presence of MoSe₂, as well as determine its preferential growth orientation as being aligned with the graphene underneath.

XPS was carried out on 2.4 ML MoSe₂ on HOPG to understand the stoichiometry of the as grown film. Figure 2a and 2b, show Se 3d_{5/2} peak at 54.70 eV and Mo 3d_{5/2} peak at 229.04 eV that are consistent with the formation of MoSe₂³². When the Se:Mo ratio is calculated through deconvolution from the respective Mo and Se oxides, we obtain a ratio of 1.96, which is very close to the ideally expected stoichiometric value of 2. Also, no discernable signal corresponding to any excess elemental Se is observed in the XPS. When the take-off angle is varied we clearly observe that the oxide signal is greater at the surface than in the bulk. A hypothesis on the origin of this oxide is discussed in the SI. It is also noted that carbide formation is below the limit of detection, indicating that no covalent bonding of the MoSe₂ layer with HOPG is detected.

The TEM images of 9 ML MoSe₂ grown on HOPG and CaF₂ along with flakes exfoliated from bulk MoSe₂ are shown in Fig. 3. In the *cs*-TEM of MoSe₂ on HOPG (Fig. 3a), we observe a sharp interface between the conformal MoSe₂ film and HOPG. The interlayer spacing is calculated to be ~0.65 nm, which is very close to the reported value of 0.647 nm for bulk MoSe₂³³. Using FFT it is confirmed that the MoSe₂ crystal structure is indeed 2H and that the crystal plane perpendicular to the view direction is close to $(11\bar{2}0)$. In-plane TEM was performed by exfoliating MoSe₂ grown on HOPG to a TEM grid (Fig. 3b); small triangular domains of ~5 nm size stitched together are observed resulting in a near single crystal diffraction pattern locally (electron beam diameter ~150 nm). Formation of triangular grains during CVD growth of layered materials consisting of 2 different elements like h-BN, MoS₂, MoSe₂ etc.^{34,35,36} has been

previously observed. What is surprising here is the high degree of local rotational alignment because of van-der-Waals epitaxy in the MBE growth. Although such triangular features have recently been reported by other groups and studied using STM^{37,38}, the fact that these triangles are inherent in the as-grown material and not a Moiré pattern arising from interactions with the underlying substrate is evident from the diffraction pattern corresponding to HRTEM of MoSe₂ only (Fig. 3b, Inset). With increasing diameter of the electron beam, the diffraction spots get extended, gradually approaching the LEED pattern shown in Fig. 1h²⁷.

In the cs-TEM image of MoSe₂ grown on CaF₂ (Fig. 3f), two slightly misoriented grains stitched together are observed. The thin amorphous CaF₂ layer right below the MBE grown MoSe₂ is due to the loss of crystal structure during the TEM sample preparation, since CaF₂ is known to be very sensitive to radiation damage by electron or ion beam²⁸. For thicker regions of the TEM sample (Inset f1 of Fig. 3f), we can see crystalline CaF₂ up to the interface with MoSe₂. Along the growth direction, the layers are well oriented in a 2H crystallographic form. However, in the growth plane a greater polycrystallinity is observed (Fig. 3g) as compared to MoSe₂ grown on HOPG (Fig. 3b). It is also observable in the in-plane TEM and the diffraction (Inset g1 of Fig. 3g) that majority of the MoSe₂ grains have a preferential orientation. But faint rings in the diffraction pattern are discernable, resulting from misoriented grains. The preferred orientation is aligned along the underlying CaF₂ crystal, as evident in Inset g2 of Fig. 3g. We can detect $\{220\}$ diffraction of CaF₂ (green dots) aligned with the $\{110\}$ or $\{11\bar{2}0\}$ diffraction of MoSe₂. This is consistent with the observed RHEED streaks of MoSe₂ along $\langle 11\bar{2}0 \rangle$ appear at the same position as the $\langle 110 \rangle$ of CaF₂ and with the relaxed growth as the lattice MBE grown MoSe₂ on CaF₂ is

close to that of bulk MoSe₂. The fact that we do not observe all 6 spots corresponding to {220} of CaF₂ is due to tilt of the sample with respect to the zone axis. Finally, Fig. 3e shows the in-plane TEM of exfoliated MoSe₂ from a bulk sample that was imaged under the same conditions as the other in-plane TEM images. It proves that the features seen in MBE-grown material are intrinsic to the growth and not artifacts of the imaging.

The optical properties of the MBE MoSe₂ of varying thicknesses along with bulk MoSe₂ are shown in Fig. 4, including Raman, PL and absorption spectra. Similar to 2H-MoS₂, 2H-MoSe₂ belongs to the D_{6h} group. Theoretical analysis predicts three Raman-active in-plane modes E_{1g}, E¹_{2g}, and E²_{2g}, one active out-of-plane mode A_{1g}, and two inactive B_{1u} and B_{2g} modes³⁹. In our experiment (Fig. 4a), few-layer and bulk MoSe₂ were analyzed using a 488 nm laser of 3 mW laser power. Strong E¹_{2g} and A_{1g} Raman peaks and weak E_{1g} and B_{2g} peaks are observed. Raman signal from bulk MoSe₂ has been observed to be much weaker as compared to few-layer MoSe₂^{34,40}. In case of bulk low laser power results in low signal to noise causing almost indiscernible E¹_{2g}⁴⁰. Hence, we used higher power and in Fig. 4a spectra were normalized with respect to A_{1g} peak intensity. For comparison, We detect the A_{1g} peak at ~244.2 cm⁻¹ and E¹_{2g} peak at 286.1 cm⁻¹ and no B_{2g} for bulk MoSe₂ in agreement with literature^{34,41}. In a normal incident backscattering Raman setup on a basal plane as used in this work, the E_{1g} mode is theoretically forbidden⁴². The peak observed at ~170 cm⁻¹ is assigned to the E_{1g} peak of MoSe₂ as no other Raman peaks are expected theoretically at that value⁴³. This E_{1g} peak might arise due to a slight deviation from the laser beam normal incidence on the basal plane, a 2 photon process⁴⁴, or an appreciable crystallographic disorder. The inactive mode B_{2g} has been reported to become Raman active in few layer 2H-MoSe₂ due to the breakdown of translation symmetry⁴⁰, which is perhaps the reason we observe it in the MBE grown materials. In 9 ML MoSe₂ on CaF₂ and HOPG we

observe the A_{1g} peak at $\sim 242.1 \text{ cm}^{-1}$ (a red shift from the bulk) but the E_{2g}^1 peak are at 289.5 cm^{-1} and 286.7 cm^{-1} (a blue shift from the bulk), respectively. The likely explanation for the relative shifts observed in Raman peaks is a combination of various effects such as local heating⁴⁵, dielectric environment⁴⁶, breakdown of translation symmetry in these MBE MoSe_2 layers compared to bulk and small grain size in MBE grown material. Difference in local heating is due to the different thermal conductivity of different substrates. The broadening in both A_{1g} and E_{2g}^1 peaks could be attributed to the small grain size of these MBE MoSe_2 films causing special localization of phonons⁴⁷. The main Raman peak characteristics are summarized in Fig. 4b. The fact that there is no interlayer chemical interaction when MoSe_2 is grown on epitaxial graphene on SiC is confirmed by the Raman spectrum of epitaxial graphene before and after growth. Raman spectra from MoSe_2 and graphene are simultaneously observed, as shown in Fig. 4b. After the growth of MoSe_2 , the 2D peak of graphene is shifted by about $\sim 11 \text{ cm}^{-1}$. Shift in the graphene 2D peak (13 cm^{-1}) in a mechanically exfoliated MoS_2 /exfoliated graphene/ SiO_2 structure has been recently observed and attributed to in-plane compressive strain on graphene due to encapsulation of graphene by MoS_2 ⁴⁸. In our case, such strain or change in dielectric environment⁴⁶ could be used to explain the observed shift.

Photoluminescence (PL) from monolayer MoSe_2 grown by MBE on HOPG at 77K and epitaxial graphene on SiC at room temperature (RT) and 77K has been very recently reported²⁷. Here we report the RT PL from monolayer MoSe_2 grown on CaF_2 and epitaxial graphene on SiC, shown in Fig. 4d. A PL peak at $\sim 1.563 \text{ eV}$ on graphene and $\sim 1.565 \text{ eV}$ on CaF_2 is measured, which is close to the reported value of $\sim 1.57 \text{ eV}$ at RT for exfoliated monolayer MoSe_2 on SiO_2 ⁴⁹ and 1.55 eV at RT for MBE grown MoSe_2 on bilayer epitaxial graphene²⁷. This is consistent with our earlier claim that the growth on CaF_2 also proceeds by van der Waals epitaxy and

MoSe₂ does not chemically interact with the underlying substrate. It is worthy to note that 3 times higher laser power is necessary to obtain PL of about the same intensity from MoSe₂ on epitaxial graphene as compared to than on CaF₂, due to charge transfer from MoSe₂ to graphene. As shown below in Fig. 5, the nominal monolayer growth of MoSe₂ results in patched coverage since the 2nd layer starts to grow while the first layer has not fully coalesced. Therefore, the 1 ML MoSe₂ grown by MBE is not suitable for the large area absorption spectroscopy measurement, given a direct-indirect bandgap crossover is expected for 1 ML and 2 ML MoSe₂. The absorption coefficient (α) was measured on a 9 ML MoSe₂ on CaF₂ and plotted in Fig. 4. On the semi-log scale, a sharp band-edge with a 1000x increase in α over \sim 60 meV increase in the photon energy is observed, corresponding to a slope of about 20 meV/decade. A sharp density of states distribution near the band edge is critical for achieving sub-60 mV/dec steep slope transistor applications¹³. The bandgap of the 9 ML MoSe₂ is calculated to be 0.96 eV from a linear fit to α obtained from absorption spectroscopy plotted on a linear scale (inset Fig. 4e)⁵⁰, which is close to 1.08 eV reported in literature for the bulk MoSe₂ sample at room temperature, determined by liner fitting to square root of photocurrent measured⁵¹. This variation is probably due to the difference in measurement and fitting techniques.

In order to understand the surface morphology of the resulting MoSe₂ films, SEM (Fig. 5a and Fig. 5c) and AFM (Fig. S5b and Fig. S5d) characterizations were carried out on the 9 ML samples. These images show that high protrusions on HOPG and wrinkles on CaF₂ are formed on the surface. The cs-TEM image (Fig. 5b) shows one of these protrusions formed in MoSe₂ on HOPG, which is \sim 20 nm tall, much higher than the thickness of the grown MoSe₂. Through a close inspection of a series of such protrusions, it is found that when the surface step height variation in HOPG is on the order of several monolayers thick, the MoSe₂ domains on the two

sides of the step interact to form these high aspect ratio protrusions. These are unlikely to be wrinkles due to the thermal expansion coefficient mismatch between MoSe₂ and HOPG since MoSe₂ has a positive thermal expansion coefficient: a_a (basal-plane) of $\sim 7.24 \times 10^{-6} \text{ }^\circ\text{C}^{-1}$ and a_c (out-of-plane) of $\sim 12.93 \times 10^{-6} \text{ }^\circ\text{C}^{-1}$ ⁵², while HOPG has a small and negative coefficient of linear expansion ($\sim -1 \times 10^{-6} \text{ }^\circ\text{C}^{-1}$) in the basal plane below 400 °C⁵³. Therefore, as the HOPG cools, it expands, whereas the MoSe₂ film shrinks. Hence, one would expect cracks rather than wrinkles/protrusions. In the case of CaF₂, its coefficient of linear thermal expansion is $\sim 28 \times 10^{-6} \text{ }^\circ\text{C}^{-1}$ at the growth temperature (400 °C) and $\sim 18 \times 10^{-6} \text{ }^\circ\text{C}^{-1}$ ⁵⁴ at RT whereas for MoSe₂ it is less than half this value as noted earlier. Consequently, as the temperature is reduced, CaF₂ contracts much more than MoSe₂. Wrinkles are indeed observed (Fig. 5c and 5d) in the 9 ML MoSe₂ grown on CaF₂, similar to CVD growth of graphene⁵⁵. Cs-TEM of the wrinkle (Fig. 5d) shows hollow space inside the wrinkle as expected.

To gain more understanding of the growth process, sub-monolayer (0.6 ML) growth of MoSe₂ on HOPG and epitaxial graphene was also carried out. A large density of nucleation was found, and both SEM and AFM images (Fig. 5e & 5f) clearly show that the 2nd layer grows before the 1st layer coalesces. The similar growth morphology was also very recently reported using scanning tunneling microscopy (STM) on MBE grown MoSe₂ on epitaxial graphene²⁷. Both these growths can be explained by a low Mo adatom mobility due to the high Mo melting temperature and much lower temperature of the substrate in comparison. It is interesting to note that these flower shaped domains in Fig. 5e are formed by stitching of the much smaller triangular grains observed by TEM (Fig. 3b). In passing, it is also noted that Mo adatoms do move as we can observe greater nucleation along the step edges of HOPG (see Fig. S5). This observation could be used to design growth experiments to induce layer-controlled growth.

We have discussed the similarities and differences in MBE growth of MoSe₂ on HOPG and epitaxial graphene (van der Waals substrates) and CaF₂ (quasi- van der Waals substrate due to inert surface fluorine termination). We observe that the growth occurs by van der Waals epitaxy in both cases and result in close to stoichiometric 2H oriented films. But the grains in the two cases are very different. Whether the underlying cause of this discrepancy is the quality of the substrate or something more fundamental is yet unclear. Raman features corresponding to MoSe₂ formation are observed. A shift of the 2D peak of graphene due to MoSe₂ is detected, implying an environmental dielectric interaction in spite of a lack of a detectable chemical interaction between the graphene substrate and MoSe₂. PL from monolayer MoSe₂ on CaF₂ at ~1.565 eV, on epitaxial graphene at ~1.563 eV and the bandgap of thick MoSe₂ of ~0.96 eV are measured, all at RT, very close to that from CVT grown MoSe₂. Finally, features resulting from growth of thick films on HOPG and CaF₂ have been investigated using SEM, AFM and cs-TEM. We believe this detailed study of the MBE grown TMD material, esp. using electron microscopy, in this paper would be a stepping-stone for design and benchmarking of MBE growth of 2D layered materials.

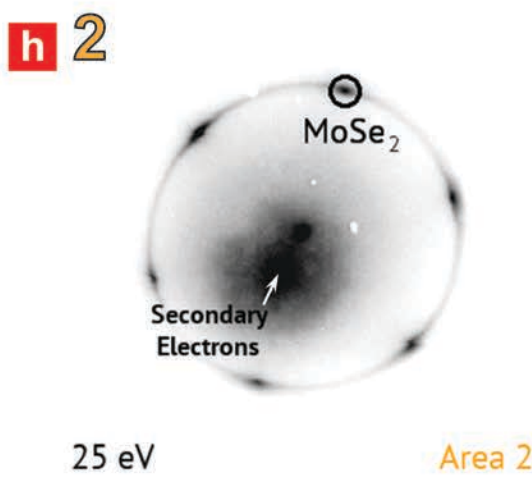
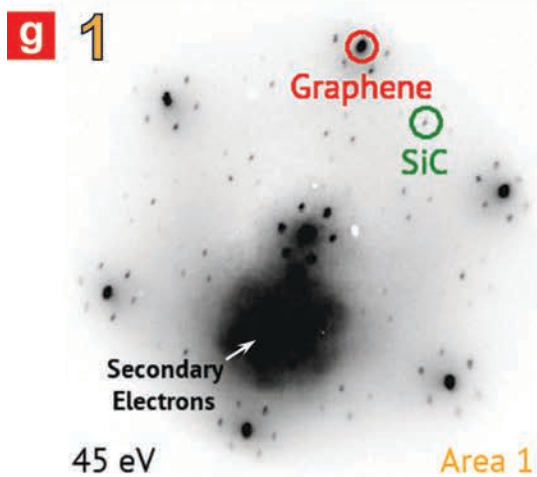
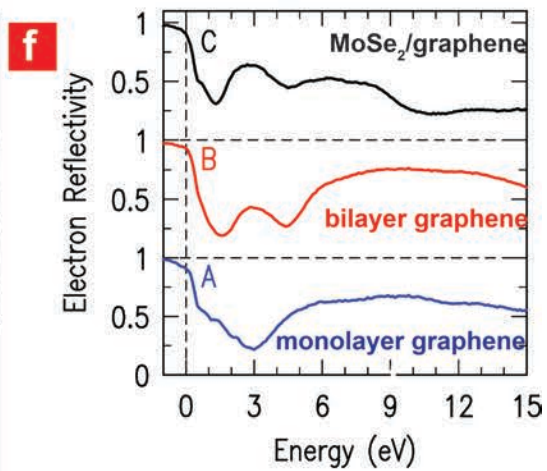
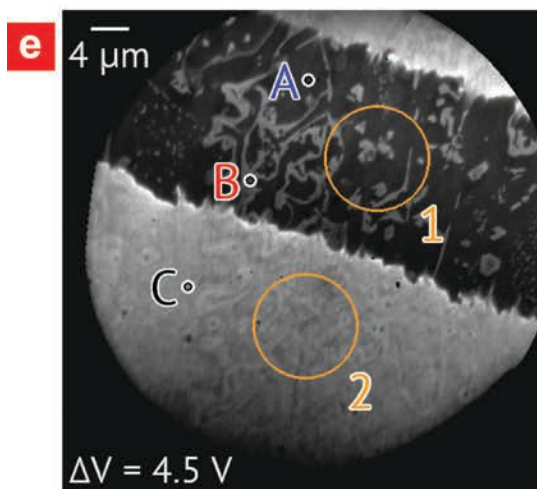
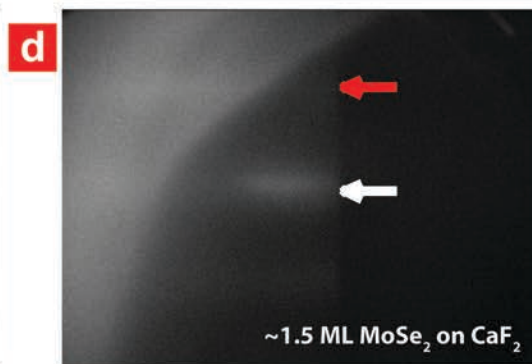
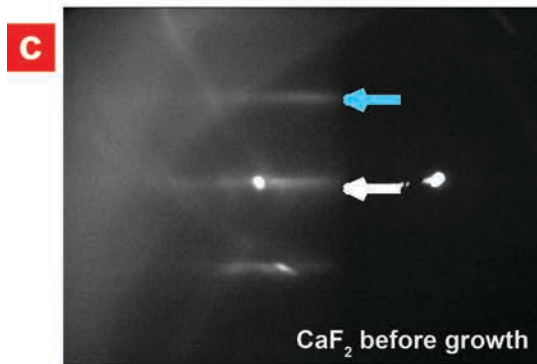
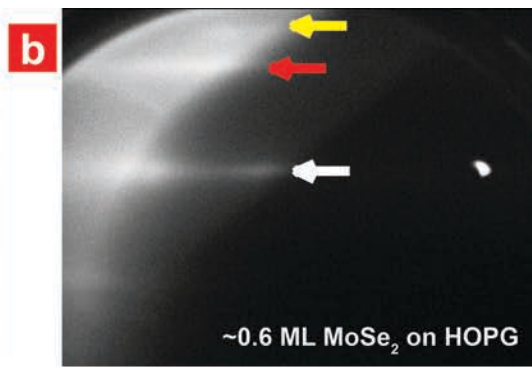
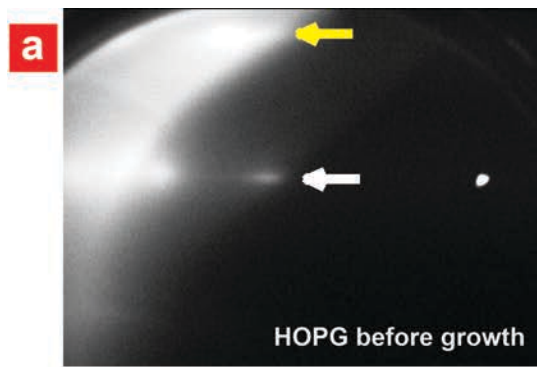


Figure 1: (a-d) RHEED images and (e-h) low electron energy analysis on 2.4 ML MoSe₂ on epitaxial graphene on SiC with part of the graphene substrate exposed. RHEED from (a) HOPG before growth, (b) ~0.6 ML MoSe₂ growth (Yellow arrow: HOPG and Red arrow: MoSe₂), (c) CaF₂ before growth, and (d) ~1.5 ML MoSe₂ growth on CaF₂. The RHEED behavior of MoSe₂ on epitaxial graphene is similar to that on HOPG, shown in Fig. S1. (e) LEEM image showing regions where LEER (f) and LEED (g and h) were performed. (f) LEER of monolayer graphene, bilayer graphene and 2.4 ML MoSe₂ on graphene. (g) LEED from graphene/SiC and (h) 2.4 ML MoSe₂ on graphene/SiC.

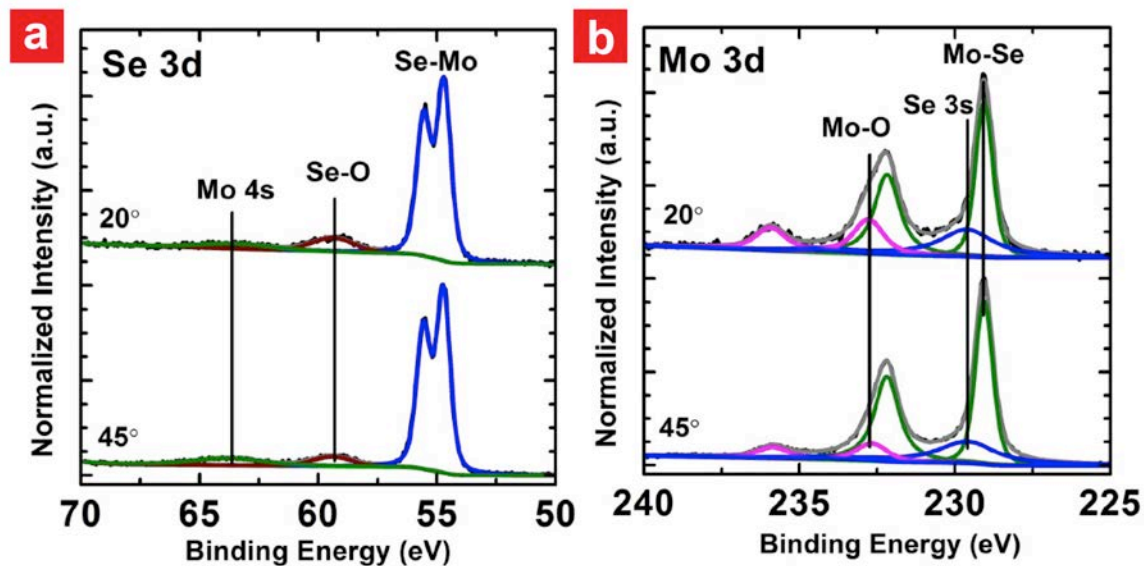


Figure 2: Angle resolved XPS spectra from 2.4 ML MoSe₂ grown on HOPG showing the (a) Se 3d and (b) Mo3d and Se 3s core levels, taken at 45° (bulk sensitive) and 20° (surface sensitive) take-off angles.

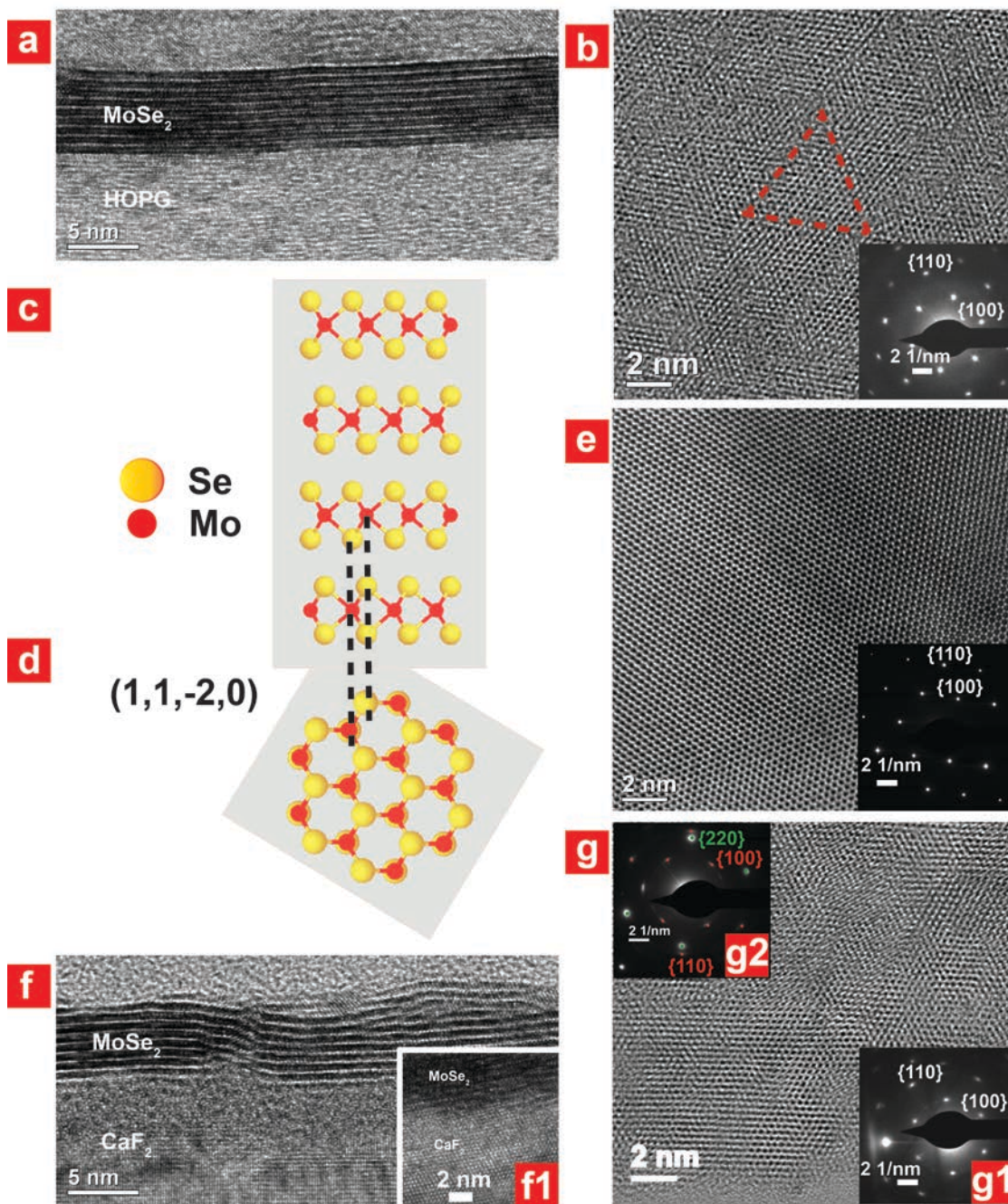


Figure 3: (a-b) 9 ML MoSe₂ on HOPG: (a) cs-TEM and (b) in-plane MoSe₂ TEM images with an inset showing the diffraction pattern from the same region. (c-d) Crystal model of 2H MoSe₂:

(c) cross-section showing the $(11\bar{2}0)$ plane and (d) top view. (e) In-plane TEM along with the

diffraction pattern of exfoliated flakes from bulk MoSe₂. (f-g) 9 ML MoSe₂ on CaF₂: (f) cs-TEM (inset f1 is from a thicker region of the TEM sample, showing crystalline CaF₂ and MoSe₂ interface.) and (g) in-plane MoSe₂ TEM images along with the diffraction pattern (inset g1). The other inset g2 shows diffraction patterns from a fragment of CaF₂ with MBE grown MoSe₂: the diffraction dots in green are for CaF₂ and the diffraction dots in red are for MoSe₂.

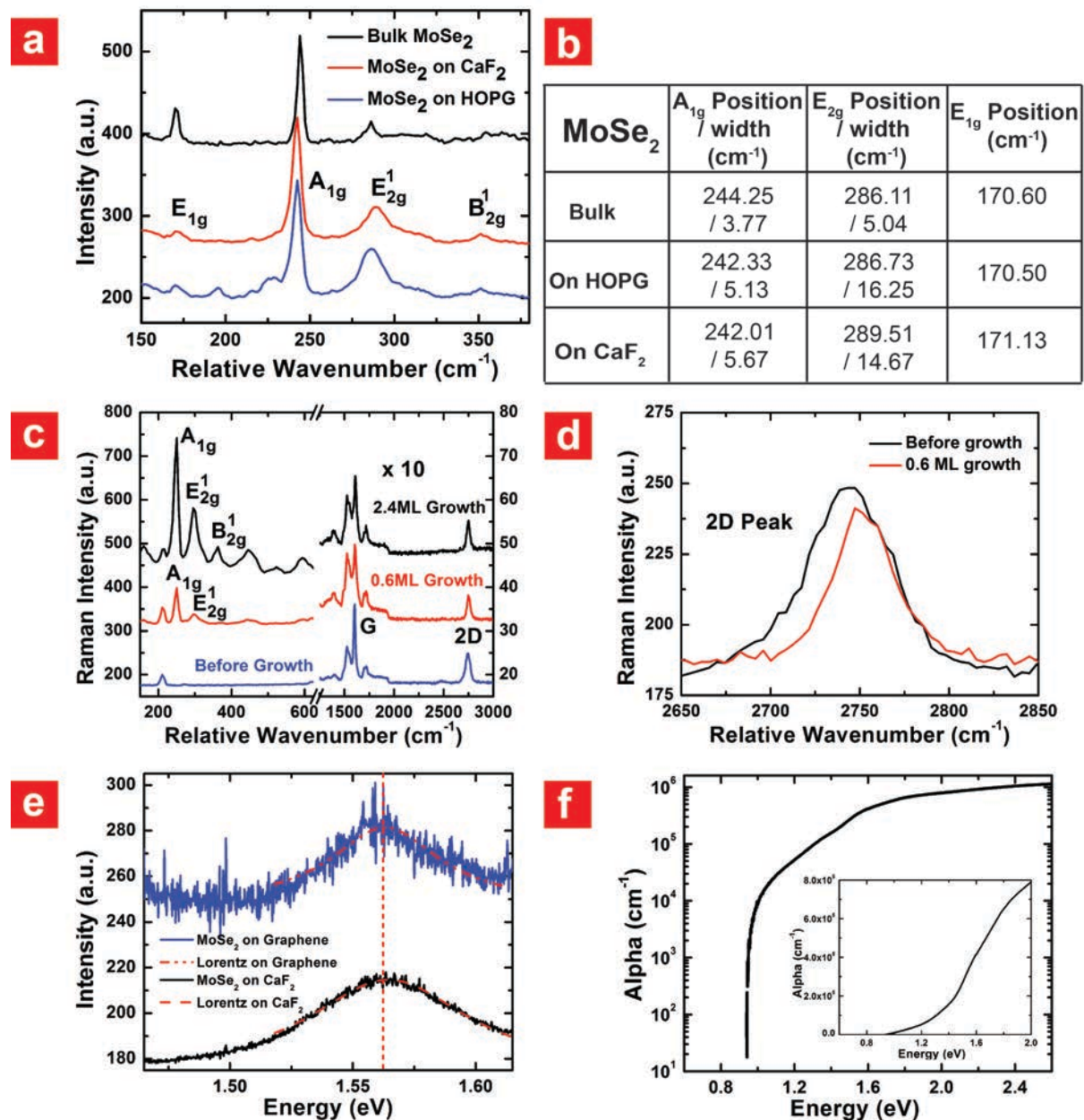


Figure 4: (a) Raman spectrum of 9 ML MoSe₂ grown on CaF₂ and HOPG compared to bulk MoSe₂. (b) lists the Raman peak positions obtained by Lorentzian fitting. (c) Evolution of Raman for MoSe₂ grown on epitaxial graphene/SiC, and (d) Raman shift in 2D peak of epitaxial graphene after growth of MoSe₂. (e) RT PL from ~1 monolayer MBE grown MoSe₂ on epitaxial graphene and CaF₂. (f) Semi-log plot of absorption coefficient measured on 9 ML MoSe₂ on CaF₂ (Inset: linear plot of the same data).

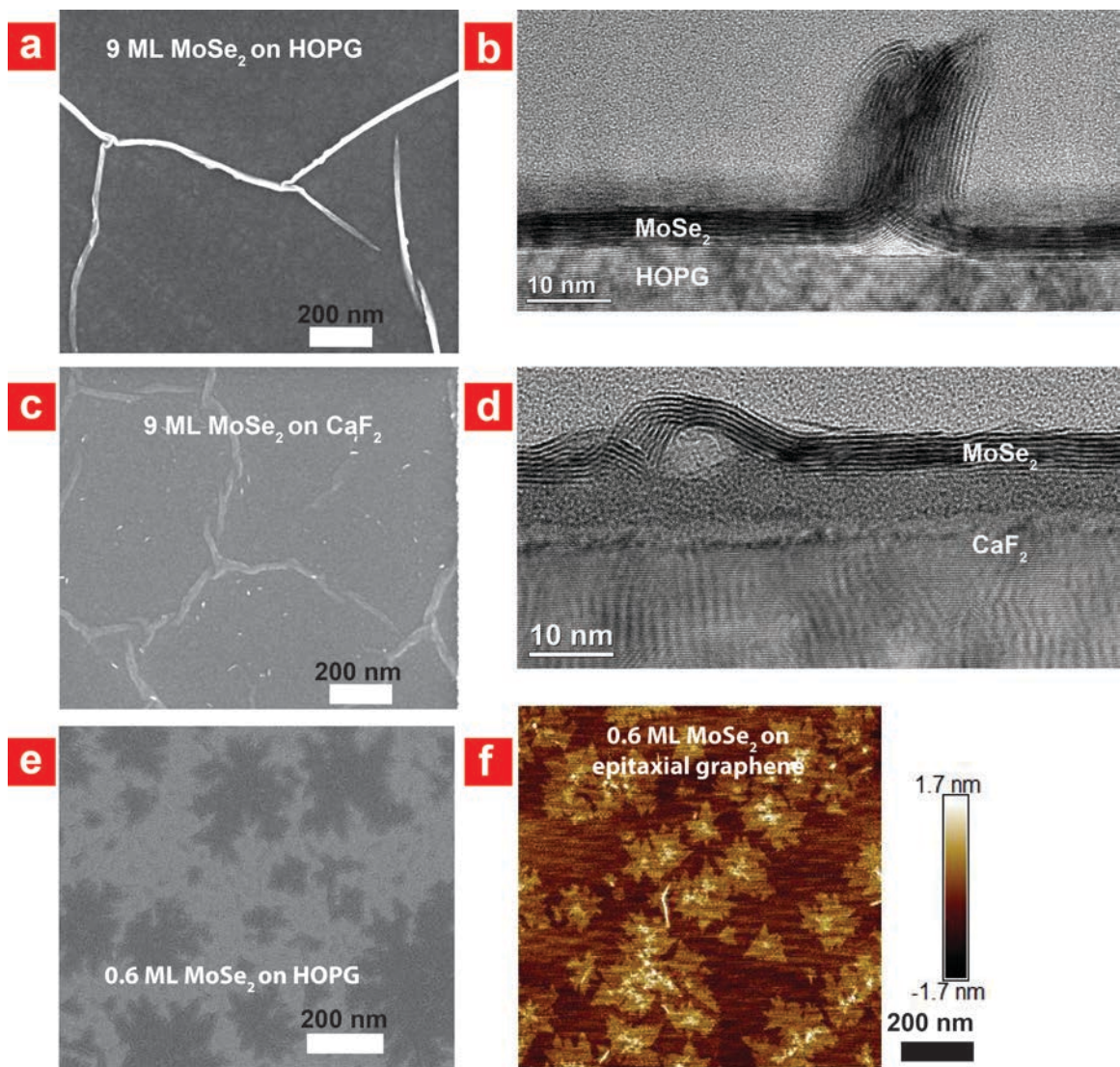


Figure 5: (a) SEM of the surface of 9ML MoSe₂ grown on HOPG (b) Cross-section of one of the protrusions of MoSe₂ on HOPG (c) SEM of the surface of 9 ML MoSe₂ grown on CaF₂ (d) Cross-section of one of the wrinkles of MoSe₂ on CaF₂ (e) SEM of the surface of 0.6 ML MoSe₂ grown on HOPG (e) AFM of 0.6 ML of MoSe₂ on epitaxial graphene on SiC.

ASSOCIATED CONTENT

Supporting Information. Additional information, methods, instrumentation and figures.

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Author Contributions

The manuscript was written through contributions of all authors. All authors have given approval to the final version of the manuscript.

Notes

The authors declare no competing financial interest.

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Supplementary information of

Molecular beam epitaxial growth of MoSe₂ on graphite, CaF₂ and graphene

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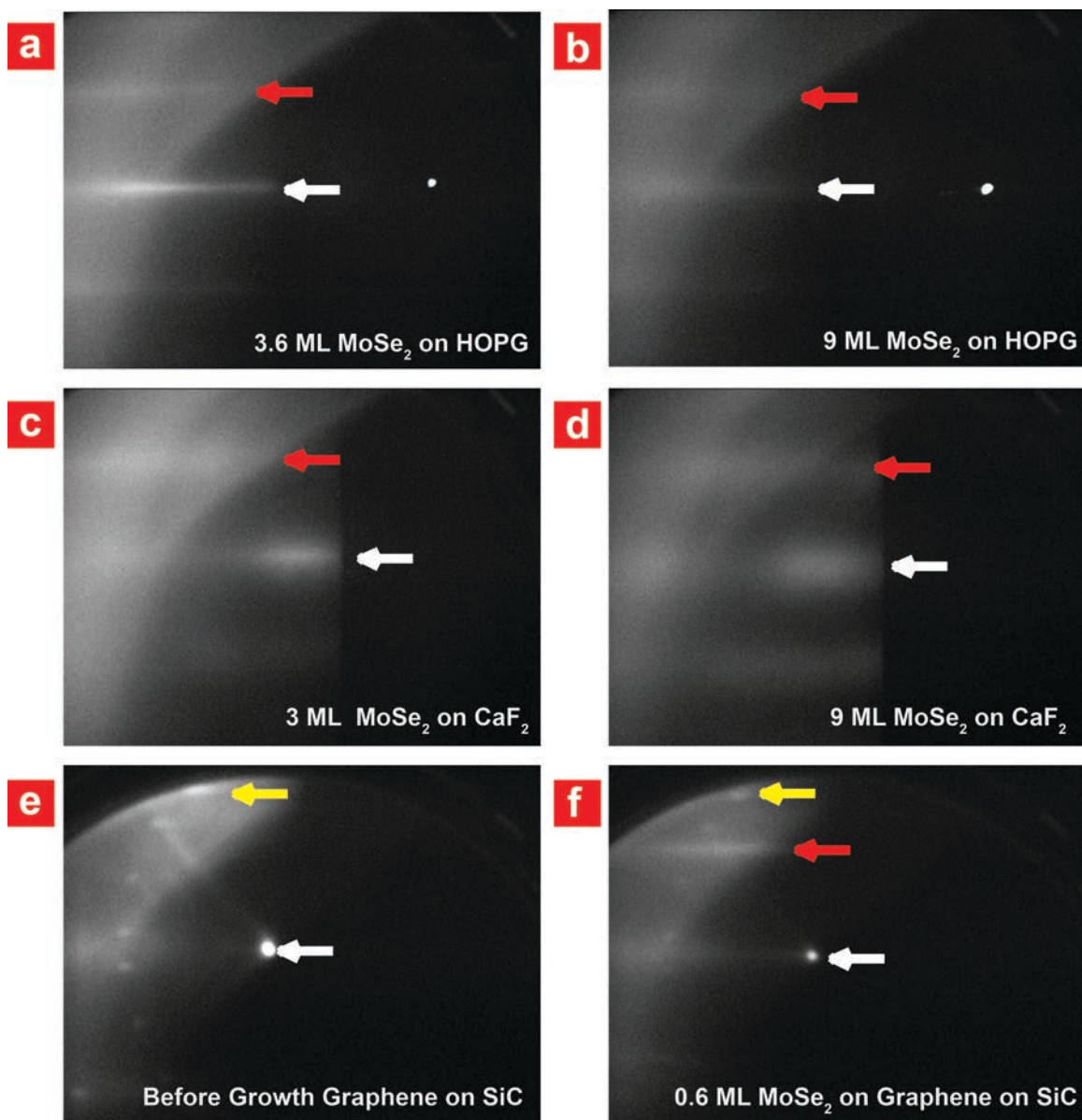


Figure S1: RHEED images from MoSe₂ growth on (a-b) HOPG, (c-d) CaF₂, and (e-f) epitaxial graphene on SiC (Red arrows: MoSe₂).

RHEED patterns are visible for 9 ML MoSe₂. However, RHEED intensity decreases appreciably with increasing number of layers in case of MoSe₂ growth on HOPG (Fig. S1a & b) while remains nearly constant for growth on CaF₂. Similar to the case of 0.6 ML growth of MoSe₂ on HOPG, RHEED on 0.6 ML MoSe₂ growth on epitaxial graphene, shows patterns from both MoSe₂ and graphene.

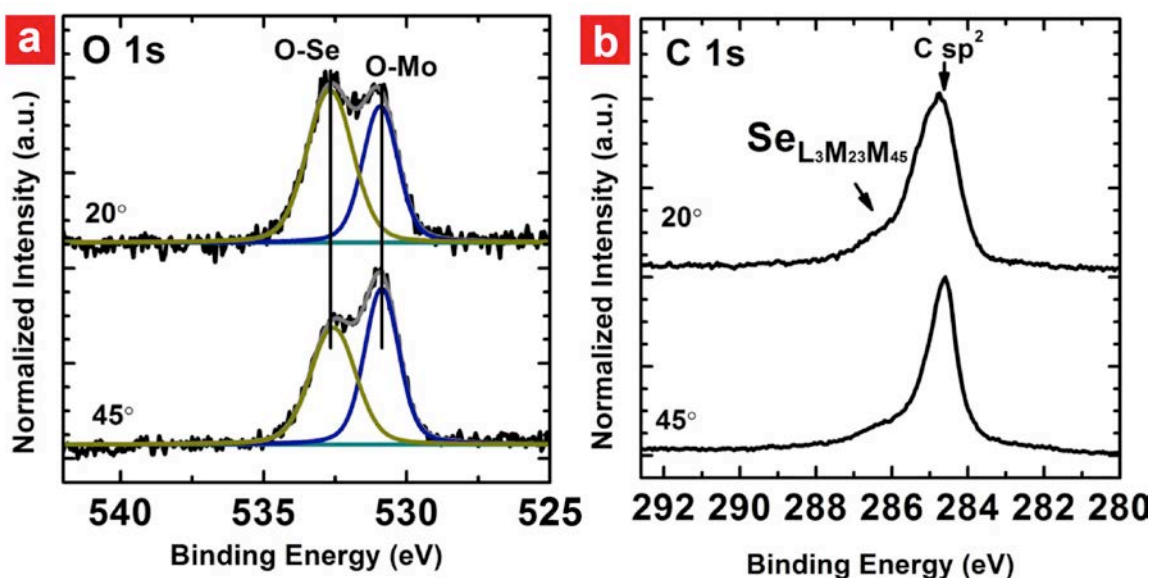


Figure S2: Angle dependent XPS showing the core levels of oxygen and carbon from MoSe₂ grown on HOPG.

We know from the AFM of sub-monolayer MoSe₂ on epitaxial graphene (Fig. 5f) and from previously reported STM on 0.8 ML MoSe₂ on epitaxial graphene¹ that the second layer grows

before the completion of the first layer. Also, the domains formed by stitching of the small triangular grains observed in Fig. 3b are of the order of ~ 500 nm (Fig. 5e). Since, the XPS is done ex-situ on a 2.4 ML MoSe_2 on HOPG, we expect a large number of edge sites in MoSe_2 . Higher reactivity of edges to oxygen ² has been previously observed using XPS for bulk MoSe_2 . Supported by the observation that with increasing incidence angle, a decrease in the percentage of oxygenated Mo and Se species from XPS decreases, which is in line with the greater population of edge sites at the surface as compared to the deeper layers, we believe that this oxidation is predominantly at these domain edge sites. It is also noted that there is no detectable carbide formation (~ 283 eV), indicating no detectable covalent bonding between the MoSe_2 and HOPG substrate.

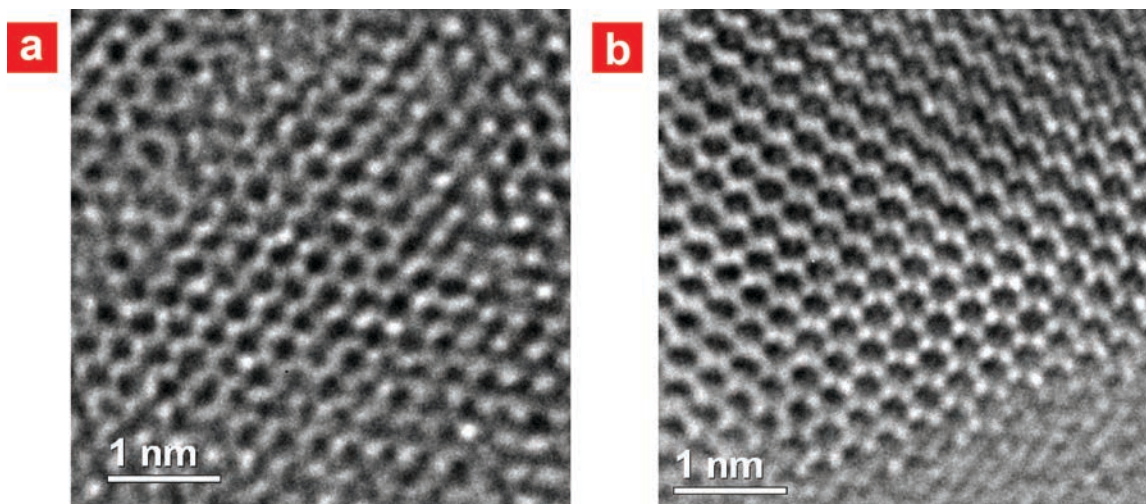


Figure S3: In-plane TEM images of MoSe₂ under similar imaging conditions: (a) grown on HOPG (b) exfoliated from bulk MoSe₂. We observe distorted crystal sites along the edges of the MBE MoSe₂ triangular domains. This is similar to the intrinsic structural defects observed in CVD MoS₂³ and is in striking contrast to the exfoliated MoSe₂ from the bulk.

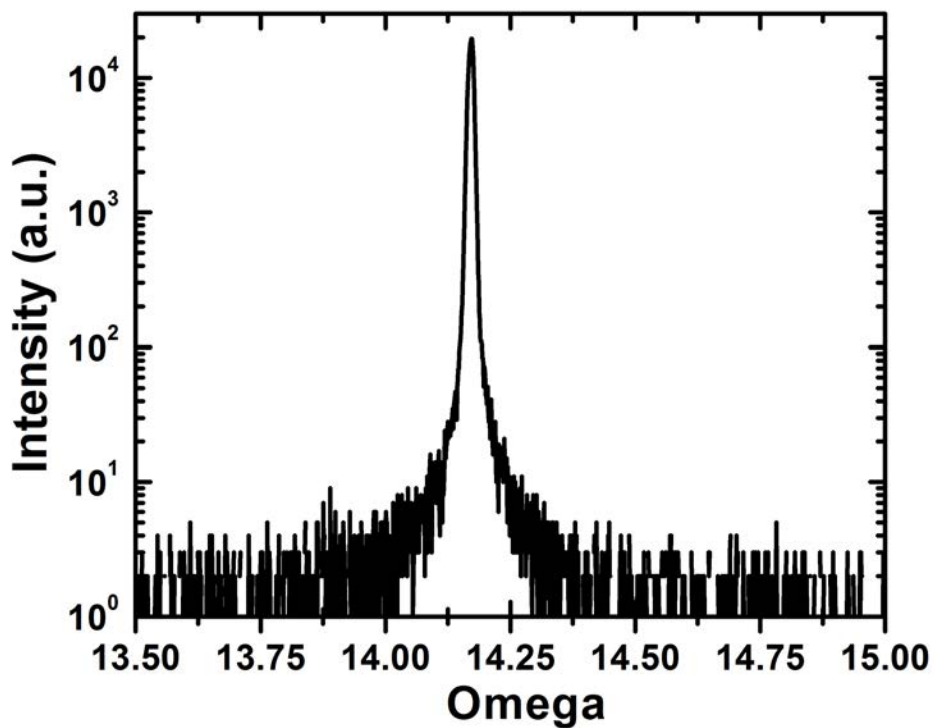


Figure S4: X-ray Diffraction rocking curve of CaF_2 substrate with a FWHM of 364.7 arcsec showing a well oriented (111) single crystal.

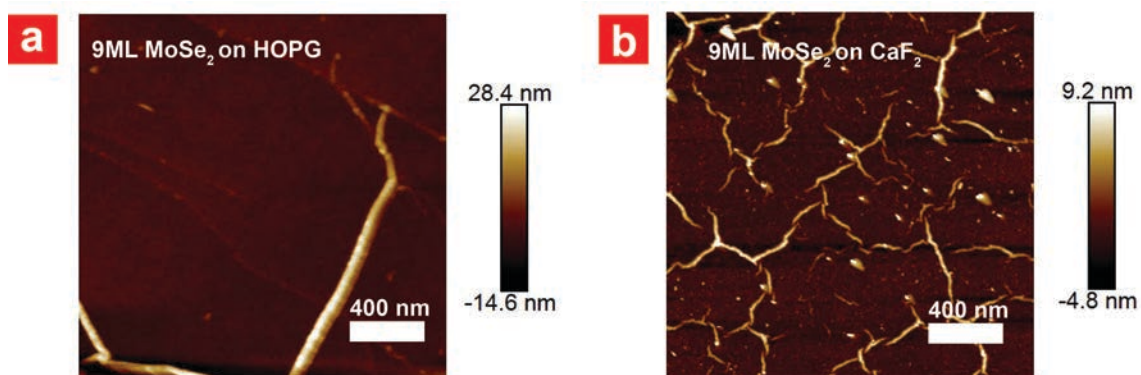


Figure S5: AFM of the surface of 9 ML MoSe_2 grown on (a) HOPG and (b) CaF_2 .

The surface features on MoSe₂ on HOPG are much taller than those on MoSe₂ on CaF₂, supporting the hypothesis that the former are protrusions and the latter are wrinkles.

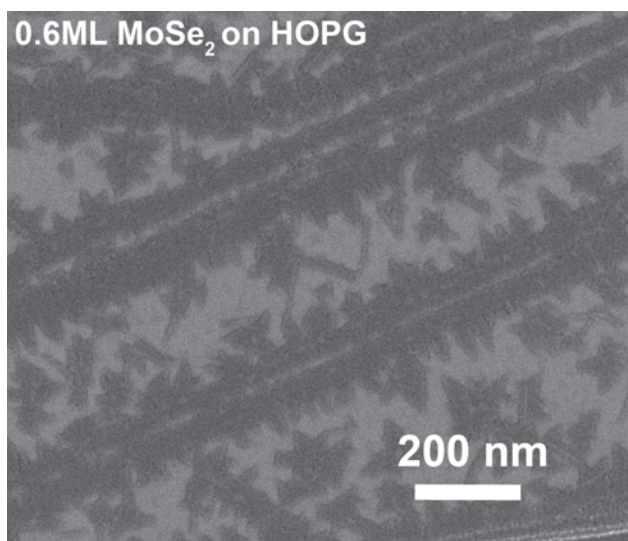


Figure S6: SEM of the surface of 0.6 ML MoSe₂ grown on HOPG, showing preferred nucleation along the steps on the substrate.

Methods and Instrumentation:

LEEM and LEED:

Low-energy electron microscopy (LEEM) and selected-area low-energy electron diffraction (μ LEED) were performed with an Elmitec LEEM III. LEEM images are acquired in bright-field mode, wherein a contrast aperture is used to allow image formation only with those electrons that

diffract into the (0,0) beam (i.e., only those electrons which diffract with zero lateral momentum). Reflectivity spectra are obtained by acquiring a sequence of images over a range of beam energies, and then extracting spectra at specific pixels in the image. μ LEED is performed by collimating the electron beam through the introduction of an illumination aperture, restricting the beam size to approximately $8\ \mu\text{m}$.

Transmission Electron Microscopy:

The atomic structure analysis was carried out on FEI Titan 80-300 Transmission Electron Microscope operated at 300kV. Titan is capable of Transmission Electron Microscope (TEM) and Scanning Transmission Electron Microscope (STEM) modes with 2 Å point-to-point resolution (below 1 Å of information limit) and 0.136 nm resolution, respectively. The cross-sectional TEM samples have been prepared by Focus Ion Beam (FIB) technique at FEI Helios Dual Beam system. In-plane TEM sample from HOPG was prepared by careful mechanical exfoliation using scotch tape and from CaF_2 was prepared by sonication of the sample in methanol followed by drop casting on to the Cu TEM grid with holey carbon support film.

Raman and Photoluminescence:

Raman and Photoluminescence (PL) measurements were performed in the backscattering configuration using a WITec Alpha 300 system at room temperature. Following are the conditions used for different samples:

Raman of bulk, 9 ML MoSe₂ on HOPG and CaF₂: 100x objective, 1800 grooves/mm grating, 488 nm laser, 3mW, 2s/point, average over 10 accumulations.

PL of 1 ML MoSe₂ on CaF₂: 100x objective, 600 grooves/mm grating, 633 nm laser, 748μW, 10 s/point, average over 10 accumulations.

PL of 1 ML MoSe₂ on epitaxial graphene: 100x objective, 600 grooves/mm grating, 633 nm laser, 2.1mW, 10 s/point, average over 10 accumulations.

X-ray Photoelectron Spectroscopy:

XPS was carried out using a monochromated Al K α source ($h\nu = 1486.7$ eV) and an Omicron Argus detector (MCD-128) operating with a pass energy of 15 eV. XPS spectra were acquired at a pass energy of 15 eV and take-off angle (defined with respect to the sample surface) of 45° and 20°. For XPS peak deconvolution, the spectral analysis software AAnalyzer was employed, where Voigt line shapes and an active Shirley background were used for peak fitting⁴.

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